

Product data sheet

1. General description

Planar passivated high commutation three quadrant triac in a SOT54 (TO-92) plastic package. This "series DN" triac balances the requirements of commutation performance and gate sensitivity and is intended for interfacing with low power drivers and logic ICs including microcontrollers.

2. Features and benefits

- 3Q technology for improved noise immunity
- Direct gate triggering from low power drivers and logic ICs
- High commutation capability with very sensitive gate
- High voltage capability
- · Planar passivated for voltage ruggedness and reliability
- Triggering in three quadrants only
- Very sensitive gate for easy logic level triggering

3. Applications

- Low power motor controls
- Small inductive loads e.g. solenoids, door locks, water valves
- Small loads in large white goods

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions	Values	Unit
Absolute	maximum rating		·	
V_{DRM}	repetitive peak off-state voltage		1000	V
I _{T(RMS)}	RMS on-state current	square-wave pulse; T _{lead} ≤ 57 °C; <u>Fig. 1; Fig. 2; Fig. 3</u>	0.8	A
I _{TSM}	non-repetitive peak forward current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	9	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C	9.9	А
Tj	junction temperature		125	°C

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Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Static cha	racteristics	· · · · ·				
I _{GT}	gate trigger current	$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G+} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	0.25	-	5	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2+ G-} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	0.25	-	5	mA
		$V_{D} = 12 \text{ V}; I_{T} = 0.1 \text{ A}; \text{ T2- G-} $ $T_{j} = 25 \text{ °C}; \text{ Fig. 7}$	0.25	-	5	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-	10	mA
V _T	on-state voltage	I _T = 0.85 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
Dynamic	characteristics	· ·				
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 670 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	-	150	-	V/µs
dI _{com} /dt	rate of change of commutating current	V_D = 400 V; T _j = 125 °C; I _{T(RMS)} = 0.8 A; dV _{com} /dt = 10 V/µs; gate open circuit;	0.5	-	-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 0.8 \text{ A}; dV_{com}/dt = 1 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	1	-	-	A/ms

5. Pinning information

Table 2.	Table 2. Pinning information							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
1	T2	main terminal 2		T2T1				
2	G	gate	Line Line Line Line Line Line Line Line	G sym051				
3	T1	main terminal 1	0 (1 (1) 0 0 0 0 0 0 0 0 0 0 0 0 0	Symoor				

6. Ordering information

Table 3. Ordering information

Type number	Package	Package					
	Name	Description	Version				
BTA2008-1000DN	TO-92	plastic single-ended leaded (through hole) package; 3 leads	SOT54				

7. Marking

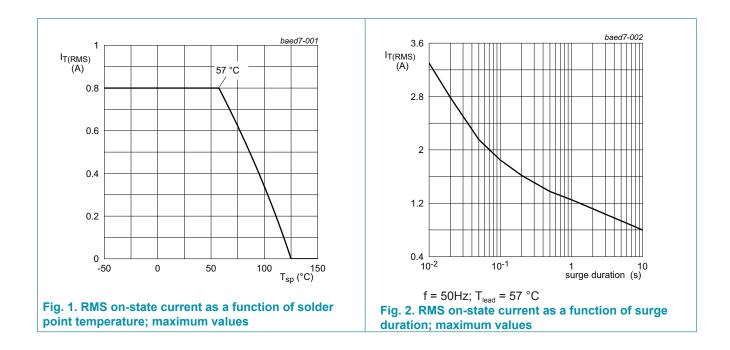
Table 4. Marking codes			
Type number		Marking codes	
BTA2008-1000DN		BTA2008-1000DN	
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8. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

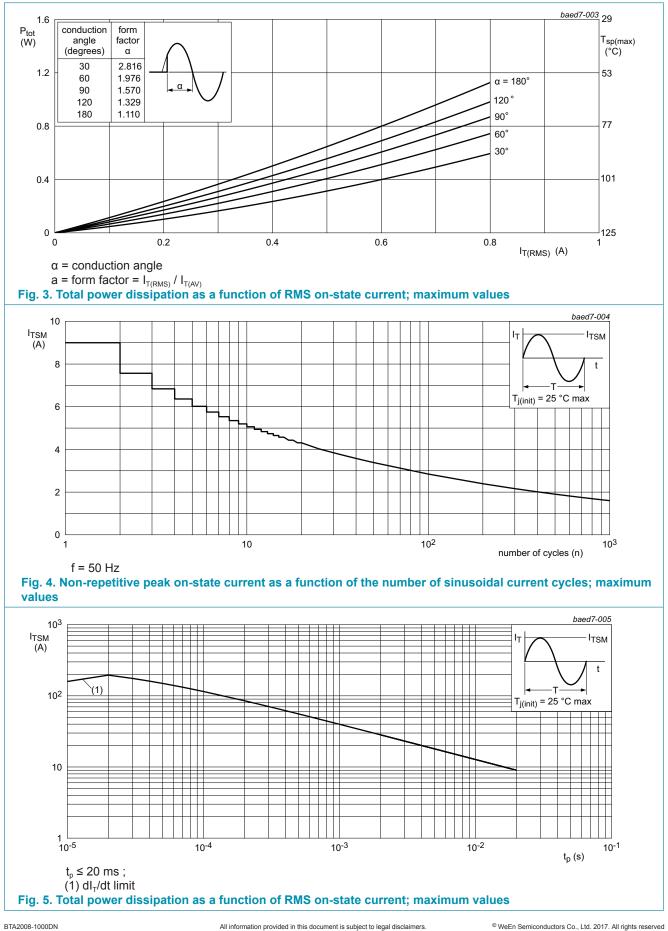
Symbol	Parameter	Conditions	Values	Unit
V _{DRM}	repetitive peak off-state voltage		1000	V
I _{T(RMS)}	RMS on-state current	full sine wave; T _{lead} ≤ 57°C; <u>Fig. 1;</u> <u>Fig. 2; Fig. 3</u>	0.8	A
I _{TSM}	non-repetitive peak on- state current	full sine wave; t_p = 20 ms; $T_{j(init)}$ = 25 °C; Fig. 4; Fig. 5	9	A
		full sine wave; t_p = 16.7 ms; $T_{j(init)}$ = 25 °C	9.9	А
l ² t	l ² t for fusing	t _p = 10ms; sine wave	0.41	A²/s
dl _⊤ /dt	rate of rise of on-state current	I _G = 10mA	100	A/µs
I _{GM}	peak gate current		1	А
P _{GM}	peak gate power		2	W
P _{G(AV)}	average gate power	over any 20 ms period	0.1	W
T _{stg}	storage temperature		-40 to 150	°C
T _j	junction temperature		125	°C



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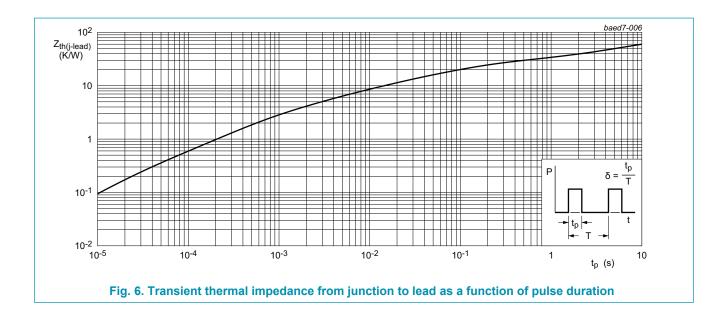
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9. Thermal characteristics

Table 5. Thermal characteristics							
Symbol	Parameter	Conditions		Min	Тур	Max	Unit
$R_{th(j-lead)}$	thermal resistance from junction to lead	<u>Fig. 6</u>		-	-	60	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air		-	150	-	K/W



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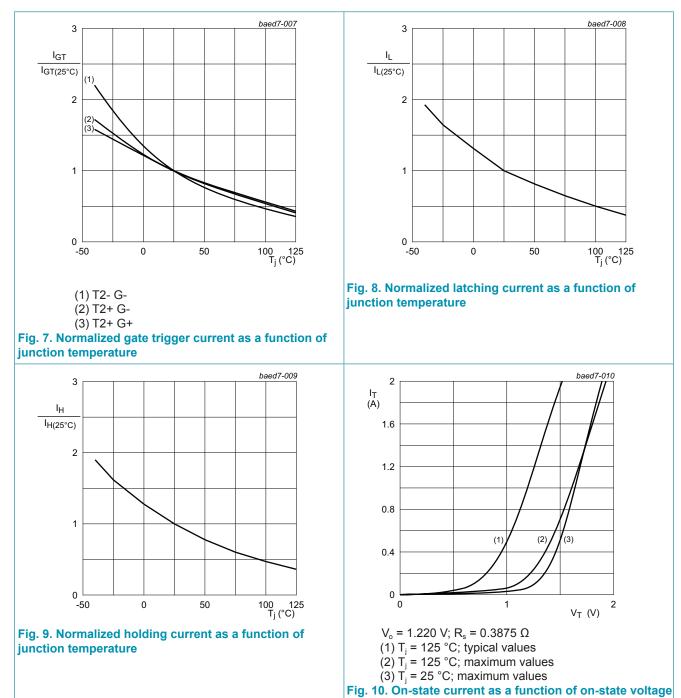
10. Characteristics

	aracteristics						
Symbol	Parameter	Conditions	Mi	n T	ӯҏ	Max	Unit
Static cha	racteristics						
I _{GT}	gate trigger current	V_{D} = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; <u>Fig. 7</u>	0.2	25 -		5	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; Fig. 7	0.2	25 -		5	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; Fig. 7	0.2	25 -		5	mA
IL	latching current	V_{D} = 12 V; I _T = 0.1 A; T2+ G+; T _j = 25 °C; Fig. 8	-	-		10	mA
		V_{D} = 12 V; I _T = 0.1 A; T2+ G-; T _j = 25 °C; <u>Fig. 8</u>	-	-		20	mA
		V_{D} = 12 V; I _T = 0.1 A; T2- G-; T _j = 25 °C; <u>Fig. 8</u>	-	-		10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	-		10	mA
V _T	on-state voltage	I _T = 0.85 A; T _j = 25 °C; <u>Fig. 10</u>	-	1	.3	1.6	V
V _{gt}	gate trigger voltage	$V_{D} = 12 \text{ V}; \text{ I}_{T} = 0.1 \text{ A}; \text{ T}_{j} = 25 \text{ °C};$ Fig. 11	-	0	.85	1	V
		V _D = 400 V; I _T = 0.1 A; T _j = 125 °C; Fig. 11	0.2	2 0	.3	-	V
I _D	off-state current	V _D = 1000 V; T _j = 25 °C	-	-		10	μA
		V _D = 1000 V; T _j = 125 °C	-	0	.1	0.5	mA
Dynamic c	haracteristics	· · · · · ·				1	
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 670 V; T _j = 125 °C; (V _{DM} = 67% of V _{DRM}); exponential waveform; gate open circuit	-	1	50	-	V/µs
dI _{com} /dt	rate of change of commutating current	$\label{eq:V_D} \begin{array}{l} V_{\text{D}} = 400 \text{ V}; \text{T}_{\text{j}} = 125 ^{\circ}\text{C}; \text{I}_{\text{T(RMS)}} = 0.85 \text{ A}; \\ \text{d} \text{V}_{\text{com}} / \text{d} \text{t} = 10 \text{V} / \mu \text{s}; \text{ gate open circuit} \end{array}$	0.9	5 -		-	A/ms
		$V_D = 400 \text{ V}; \text{ T}_j = 125 \text{ °C}; \text{ I}_{T(RMS)} = 0.85 \text{ A};$ $dV_{com}/dt = 1 \text{ V}/\mu\text{s}; \text{ gate open circuit}$	1	-		-	A/ms

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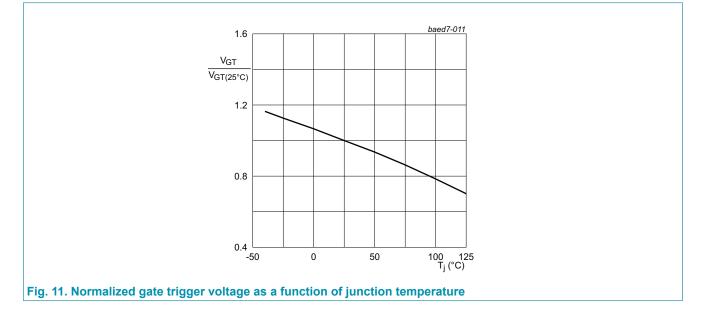
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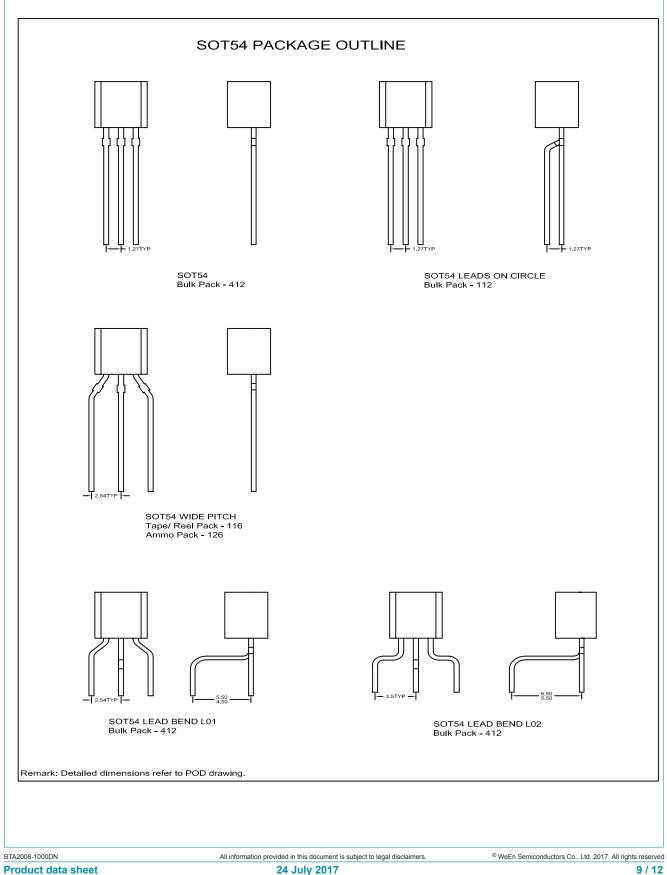
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11. Package outline



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12. Legal information

Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

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